FORM PTO-1595	06-25-2	2007	J.S. DEPARTMENT OF COMMERCE		
(Rev. 6-93)		PLE GUAL (EU) BIES (ESL	Patent and Trademark Office SHEET		
			MEE!		
	103418	694	Attorney Docket No.: 065542-5049		
To the Commissioner for Patent Please record the attached original docum			ASSIGNMENT RECORDATION SERVICES		
1. Name of conveying party(ies): 2. Name and address of receiving party(ies):					
Dong-Joon KIM		Name: Magn	aChip Semiconductor Ltd.		
Sung-Gyu PYO					
Additional names of conveying party(ies)) attached?	Internal Addr	ess:		
		Street Addres	ss: 1, Hyangjeong-dong, Heungduk-gu Cheongju-si, Chungcheongbuk-do 361-725, Republic of Korea		
3. Nature of conveyance:		City:	•		
		State:	Zip:		
" =	of Name				
Other		Additional na	me(s) & address(es) attached?		
Execution Date: May 30, 2007		☐ Yes 🏻] No		
4. New Application number(s) or paten	t number(s): NE		-		
If this document is being filed together w	ith a new applica	tion the executi	on date of the application is:		
,	May 30, 2007				
A. Patent Application No.(s)		B. Patent No.((s)		
Additional numbers attached: Yes No					
5. Name and address of party to whom	correspondence	6. Total num	ber of applications and patents involved: 1		
concerning document should be mail	led:				
Name: Collin W. Park			(37 C.F.R. §3.41): <u>\$40.00</u>		
Internal Address: Morgan, Lewis & Bo	sakina I I D	☐ Enclos	sed orized to be charged to Deposit Account 50-0310		
Customer No. 09629					
			ccount No. 50-0310 uplicate page if paying by deposit account)		
Street Address: 1111 Pennsylvania Ave	•	(111111111111111111111111111111111111	. Lo L 2.1 askanı arroamı)		
City: Washington State: D.C. Zip 9. Statement and Signature	20004	<u> </u>			
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true					
copy of the original document.					
Collin W. Park, Reg. No. 43,378 Queil Dul June 13, 2007					
Name of Person Signing Signature June 13, 2007 Date					
Total number of pages including cover sheet, attachments and documents: 2					

06/25/2007 DBYRNE 00000012 500310 11808876 01 PC:8021 40.00 DA

1-WA/2774483.1

PATENT REEL: 019470 FRAME: 0314

ATTORNEY	DOCKET NO.:
	SOLE/JOINT INVENTION
	(U.S. Rights Only)

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled: PACKAGE OF MEMS DEVICE AND METHOD FOR FABRICATING THE SAME

for which I/WE executed an application States Letters Patent on		ntly herewith; or filed an application for United
1 Hyangieong-dong, Heungduk-gu, Ch Assignee), is desirous of securing the en		c of Korea, whose post office address is Republic of Korea, (hereinafter referred to as invention, the application for United States Letters
acknowledged, I/WE, as assignor(s), ha unto the assignee, its lawful successors application, and all divisions, and conti- all reissues thereof; and I/WE hereby au	we sold, assigned, transferred, and set over and assigns, MY/OUR entire right, title, a nuations thereof, and all Letters Patent of t	ion the receipt of which from assignee is hereby r, and do hereby sell, assign, transfer, and set over nd interest in and to this invention and this the United States which may be granted thereon, an Patents and Trademarks of the United States to issurdance with the terms of this Assignment;
its successors and assigns, any facts knot papers when called upon to do so, exect in said assignee, its successors and assigneerally do everything possible to aid invention in the United States, it being assignee, its successors and assigns. AND, I/WE HEREBY authori in this application, to insert here in pare	own to ME/US respecting this invention are used and deliver all papers that may be necegns, execute all divisional, continuation, as assignee, its successors and assigns, to obtunderstood that any expense incident to the zero and request the attorneys I/WE have ementheses (Application No.	at further consideration, communicate with assigned the testify in any legal proceeding, sign all lawful assary or desirable to perfect the title to this invention of reissue applications, make all rightful oaths and the ain and enforce proper patent protection for this are execution of such papers shall be borne by the appropriate in the Declaration and Power of Attorney, filed 13JUN2007 the filing date and application
number of said application when known	n. , I/WE have hereunto set our hand(s).	
Full Name of Sole or First Assignor KIM, Dong-Joon	Assignor's Signature 1000 press Kin	Date 29/05/2007
Address: 1 Hyangjeong-dong, Heungbuk-gu, Ch Republic of Korea	eongju-si, Chungcheongbuk-do, 361-725,	Citizenship Republic of Korea
Full Name of Second Assignor PYO, Sung-Gyu	Assignor's Signature	Date 30/05/2001
Address: 1 Hyangjeong-dong, Heungbuk-gu, Ch Republic of Korea	Citizenship Republic of Korea	
Full Name of Third Assignor	Assignor's Signature	Date
Address:	Citizenship	
Full Name of Fourth Assignor	Assignor's Signature	Date
Address		Citizenship
Names of additional inventors attached	☐Yes ⊠No	

Morgan, Lewis & Bockius LLP

1-WA/2399560.1

RECORDED: 06/13/2007

PATENT REEL: 019470 FRAME: 0315